# **Impel Plus Backplane Connectors** and Cable Assemblies



Impel Plus Backplane Connector System achieves data rates up to 56 Gbps with superior signal integrity performance and enables backward and forward compatibility with compact compliant pins

## **Features and Advantages**

Compact, compliant-pin 56-Gbps backplane connector

Enables backward and forward compatibility with various high-end copper and cable architectures



Offers better signal integrity performance due to shallow PCB hole. Lowers PCB costs by reducing layers



Impel Plus 3-Pair, Right-Angle Daughtercard, 1.90mm Pitch

### Small compliant pin $(0.31 \text{mm} \pm -0.05)$

Reduces crosstalk by enabling optimized routing or use of pinning via

## 92 Ohms nominal impendence

Minimizes impedance discontinuities in the channel

Molex patent-pending Impel Connector technology with tightly coupled differential-pair structure

Provides optimal signal integrity and mechanical isolation through the connector system

High-speed automation line is available

Controlled manufacturing process provides

cables with reliable and consistent signal

integrity performance

for high-volume production of cable

## Innovative signal beam interface

Improves insertion loss compared to in-line signal beams. Pushes interface resonance frequency past 30 GHz





Impel Plus 3-Pair, 2.35mm-Pitch Right-Angle Orthogonal Direct Connector System

Grounding tail aligner for lead frames and wafer shields closer to daughtercard launch to improve ground return path

Minimizes impedance discontinuities. Reduces crosstalk

# IEEE 10GBASE-KR and Optical **Internetworking Forum (OIF) Stat Eye Compliant Channel**

Demonstrates end-to-end channel performance compliance

3-, 4- and 6-pair daughtercards available with a range of column sizes Delivers design flexibility



Impel Plus 4-Pair, Right-Angle Daughtercard, 1.90mm Pitch

Complete mechanical, electrical and testing capabilities available to deliver a complete backplane solution

Offers value-added cable trays

Cable Assemblies Available with Impel Plus 3-, 4- and 6-Pair Daughtercards and Impel Cables (Assembly with Impel 6-Pair Daughtercard pictured)

Assemblies with Impel Cables up to 3.0m long can be configured with 3-, 4- and 6-pair Impel Plus Daughtercards Supports design flexibility to maximize density of differential pairs with cables

# **Impel Plus Backplane Connectors and Cable Assemblies**



# **Applications**

Telecommunications/Networking

Servers

Switches

Routers

**Data Center Solutions** 

Servers

Storage Systems

Medical

Patient monitoring



High-End Server

# **Specifications**

#### REFERENCE INFORMATION

Packaging: Tray UL File No.:

Mates With: Impel Vertical Backplane Headers (see

other available Impel header options)

OD Daughtercard (Series 171510) mates with OD

Header (Series 173460) Designed In: Millimeters

RoHS: Yes Halogen Free: Yes

#### **ELECTRICAL**

Electrical

Voltage (max):150V AC RMS Current (max): 0.75A

Contact Resistance: 100mA; 20mV Dielectric Withstanding Voltage: 500V AC

Insulation Resistance: 500V

#### **MECHANICAL**

Insertion Force to PCB (max.): 26.69N per tail Mating Force: 60g per signal; 80g per shield

Unmating Force (min.): 60g Durability (min.): 200 Cycles

# PHYSICAL

Housing: LCP Contact: Copper Alloy

Plating:

Contact Area —  $0.76~\mu m$  ( $30\mu$ ") Gold (Au) Solder Tail Area — select Matte Tin (Sn)

Underplating — Nickel (Ni)
PCB Thickness (min.): 1.00mm
Operating Temperature: -55° to +85°C

# **Ordering Information**

Series No.	Component	Pitch (mm)	Number of Pairs
<u>172730</u>	Daughtercard	1.9	3
<u>204066</u>		1.9	4

Series No.	Component	Orientation	Pitch (mm)	Number of Pairs
<u>171510</u>	Orthogonal Direct Daughtercard	Dialet Analo	0.05	
<u>173460</u>	Orthogonal Direct Header	Right Angle	2.35	3

Series No.	Component	Pitch (mm)	Number of Pairs
Contact Molex	Daughtercard	3	4
		1.9	6

Custom Product	Description
Contact Molex	Assemblies with Impel Plus Daughtercard and Impel Cables

www.molex.com/link/impel.html